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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of :
Woo-Chang Jung : Group Art Unit: 2822
Application No. 10/673,937 : Examiner Ida M. Soward
Filed: September 30, 2003 :

For: METHOD OF MANUFACTURING INSULATING LAYER AND SEMICONDUCTOR
DEVICE INCLUDING INSULATING LAYER, AND SEMICONDUCTOR DEVICE
FORMED THEREBY

SUBMISSION OF AMENDMENT

U.S. Patent and Trademark Office
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria VA 22314

Sir:

Applicants wish to thank the Examiner for the courtesy of a telephone call to the undersigned in which the Examiner asked for a status-update with respect to the above-identified application.

In reviewing the undersigned's file of the application, it is noted that a RESPONSE TO THE NOTICE OF NON-COMPLIANT AMENDMENT was timely filed on May 18, 2005. A copy of that RESPONSE is attached. It can be seen that the RESPONSE correctly sets forth the serial number of the application.

A TRANSMITTAL LETTER was also filed on May 18, 2005. A copy of the TRANSMITTAL LETTER is attached. As shown by the hand-correction (initialed and dated by the undersigned), the TRANSMITTAL LETTER contained a typographical error in the serial number.

A post card receipt was additionally filed on May 18, 2005. A copy of the date-stamped and returned post card receipt is attached. As shown by the

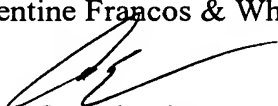
hand-correction (initialed and dated by the undersigned), the post-card contained a typographical error in the serial number.

Notwithstanding the afore-mentioned typographical errors in the TRANSMITTAL LETTER and the post card receipt, Applicants respectfully contend that the RESPONSE TO THE NOTICE OF NON-COMPLIANT AMENDMENT was timely filed on May 18, 2005, for the following reasons:

1. The RESPONSE TO THE NOTICE OF NON-COMPLIANT AMENDMENT filed on May 18, 2005, contained the correct serial number; and
2. The PAIR system of the U.S.P.T.O. shows that the RESPONSE TO THE NOTICE OF NON-COMPLIANT AMENDMENT was actually received on May 18, 2005, and placed in the "file" of application serial number 10/637,693.

For at least the reasons stated above, entry of the attached RESPONSE TO THE NOTICE OF NON-COMPLIANT AMENDMENT is requested.

Respectfully submitted,
Valentine Francos & Whitt, PLLC



Adam C. Valentine
Reg. No. 33289

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Fax 571.283.0740

Date: January 4, 2006



ATTY DOCKET #: SEC.898D

Mail Stop Fee Amendment

APPLICANT: Woon-Chan JUNG et al.

DUE DATE:

SERIAL NO.: 10/637,937

FILING DATE: September 30, 2003

TITLE: METHOD OF MANUFACTURING INSULATING LAYER AND SEMICONDUCTOR DEVICE INCLUDING INSULATING LAYER, AND SEMICONDUCTOR DEVICE FORMED THEREBY

RECEIPT OF THE FOLLOWING PAPERS IS ACKNOWLEDGED:

- General Transmittal Letter
- Response to Notice of Non-Compliant Amendment

DATE: May 18, 2005

ATTY: LYP

Check No. N/A

ATTY DOCKET #: SEC.898D

Mail Stop Fee Amendment

APPLICANT: Woon-Chan JUNG et al.

DUE DATE:

SERIAL NO.: 10/637,937 *ADV 1/4/06*

FILING DATE: September 30, 2003

TITLE: METHOD OF MANUFACTURING INSULATING LAYER AND SEMICONDUCTOR DEVICE INCLUDING INSULATING LAYER, AND SEMICONDUCTOR DEVICE FORMED THEREBY

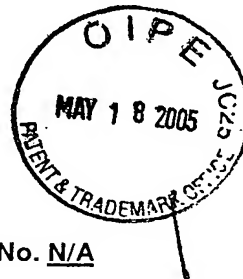
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DATE: May 18, 2005

ATTY: LYP

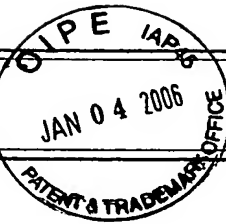
Check No. N/A



TRANSMITTAL LETTER
(General - Patent Pending)

Docket No.
SEC.898D

In Re Application Of: Woo-Chan JUNG et al.



Application No.
10/687,937

Filing Date
September 30, 2003

Examiner
Soeard, Ida M.

Customer No.
20987

Group Art Unit
2822

Confirmation No.
1631

Title: METHOD OF MANUFACTURING INSULATING LAYER AND SEMICONDUCTOR DEVICE
INCLUDING INSULATING LAYER, AND SEMICONDUCTOR DEVICE FORMED THEREBY

COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Response to the Notice of Non-Compliant Amendment

in the above identified application.

- ☒ No additional fee is required.
- ☐ A check in the amount of _____ is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. 50-0238 as described below.
- ☐ Charge the amount of _____
- ☒ Credit any overpayment.
- ☒ Charge any additional fee required.
- ☐ Payment by credit card. Form PTO-2038 is attached.

WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.

Signature

Dated: May 18, 2005

Linus Y. Park
Reg. No. 45,261
Volentine Francos & Whitt, P.L.L.C.
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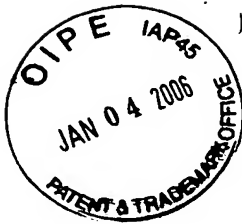
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

(Date)

Signature of Person Mailing Correspondence

Typed or Printed Name of Person Mailing Correspondence

cc:



Application No. 10/673,937
SEC.898D
Amendment dated May 18, 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of :

Woo-Chan Jung et al. : Group Art Unit: 2822

Application No.: 10/673,937 : Examiner: Soward, IDA M.

Filed: September 30, 2003 :

METHOD OF MANUFACTURING INSULATING LAYER AND
SEMICONDUCTOR DEVICE INCLUDING INSULATING LAYER, AND
SEMICONDUCTOR DEVICE FORMED THEREBY

**RESPONSE TO THE NOTICE OF NON-COMPLIANT
AMENDMENT**

U.S. Patent and Trademark Office
Customer Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In response to the Notice of non-compliant Amendment dated May 10, 2005, the Applicants submit the following claim amendments, and remarks and arguments regarding the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.